

View Online at https://aerobasegroup.com/nsn/5910-01-351-3653

# Body Style:

Chip type

**Reliability Indicator:** 

Established

## **Reliability Failure Rate Level In Percent:**

1.0000

## **Terminal Length:**

0.015 inches

#### **Body Length:**

0.055 inches

**Body Width:** 

0.055 inches

#### **Body Height:**

Between 0.020 inches and 0.057 inches

#### Schematic Diagram Designator:

No common or grounded electrode (s)

## Insulation Resistance At Maximum Operating Temp:

100000.0 megohms

#### **Capacitance Value Per Section:**

2.200 picofarads single section

## Nonderated Operating Temp:

Between -55.0 degrees celsius and 125.0 degrees celsius

# Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:

0.0 single section

## Nonderated Continuous Voltage Rating And Type Per Section:

50.0 dc single section

# Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:

-30.0/+30.0 single section

# **Tolerance Range Per Section:**

-0.10/+0.10 picofarads single section

# Case Material:

Ceramic

# Insulation Resistance At Reference Temp:

1000000.0 megohms

# Dissipation Factor At Reference Tempurature In Percent:

0.150

## **Terminal Surface Treatment:**

Solder

## **Terminal Type And Quantity:**

2 bonding pad

#### Shelf Life:

N/a



Unit Of Measure:

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Demilitarization:

Yes - demil/mli

Fiig:

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